

February 1996

DS7833/DS8833/DS7835/DS8835 Quad TRI-STATE® Bus Transceivers

General Description

This family of TRI-STATE bus transceivers offers extreme versatility in bus organized data transmission systems. The data bus may be unterminated, or terminated DC or AC, at one or both ends. Drivers in the third (high impedance) state load the data bus with a negligible leakage current. The receiver input current is low allowing at least 100 driver/receiver pairs to utilize a single bus. The bus loading is unchanged when $V_{CC} = 0V$. The receiver incorporates hysteresis to provide greater noise immunity. All devices utilize a high current TRI-STATE output driver. The DS7833/DS8833 and DS7835/DS8835 employ TRI-STATE outputs on the receiver also.

The DS7833/DS8833 are non-inverting quad transceivers with a common inverter driver disable control and common inverter receiver disable control.

The DS7835/DS8835 are inverting quad transceivers with a common inverter driver disable control and a common inverter receiver disable control.

Features

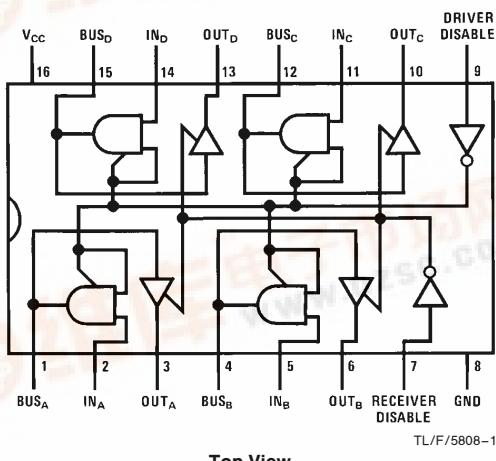
- Receiver hysteresis 400 mV typ
- Receiver noise immunity 1.4V typ
- Bus terminal current for normal V_{CC} or $V_{CC} = 0V$ 80 μA max
- Receivers

Sink	16 mA at 0.4V max
Source	2.0 mA (Mil) at 2.4V min
	5.2 mA (Com) at 2.4V min
- Drivers

Sink	50 mA at 0.5V max
	32 mA at 0.4V max
Source	10.4 mA (Com) at 2.4V min
	5.2 mA (Mil) at 2.4V min
- Drivers have TRI-STATE outputs
- DS7833/DS8833, DS7835/DS8835 receivers have TRI-STATE outputs
- Capable of driving 100Ω DC-terminated buses
- Compatible with Series 54/74

Connection Diagram

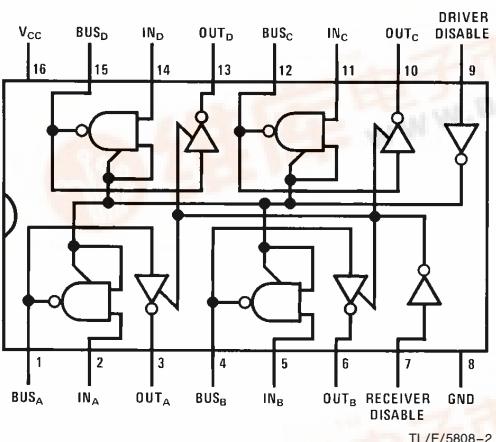
Dual-In-Line Package



Top View

Order Number DS7833J or DS8833N
See NS Package Number J16A or N16A

Dual-In-Line Package



Top View

Order Number DS7835J or DS8835N
See NS Package Number J16A or N16A

DS7833/DS8833/DS7835/DS8835 Quad TRI-STATE Bus Transceivers

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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7.0V
Input Voltage	5.5V
Output Voltage	5.5V
Storage Temperature	−65°C to +150°C
Maximum Power Dissipation* at 25°C Cavity Package	1509 mW
Molded Package	1476 mW
Lead Temperature (Soldering, 4 sec.)	260°C

*Derate cavity package 10.1 mW/°C above 25°C; derate molded package 11.8 mW/°C above 25°C.

Operating Conditions

Supply Voltage, V _{CC}	Min	Max	Units
DS7833/DS7835	4.5	5.5	V
DS8833/DS8835	4.75	5.25	V
Temperature (T _A)			
DS7833/DS7835	−55	+125	°C
DS8833/DS8835	0	+70	°C

Electrical Characteristics (Notes 2 and 3)

Symbol	Parameter	Conditions		Min	Typ	Max	Units	
DISABLE/DRIVER INPUT								
V _{IH}	High Level Input Voltages	V _{CC} = Min		2.0			V	
V _{IL}	Low Level Input Voltage	V _{CC} = Min	DS7833, DS8833, DS8835			0.8	V	
			DS7835			0.7		
I _{IH}	High Level Input Current	V _{CC} = Max	V _{IN} = 2.4V			40	μA	
			V _{IN} = 5.5V			1.0	mA	
I _{IL}	Low Level Input Current	V _{CC} = Max, V _{IN} = 0.4V			−1.0	−1.6	mA	
V _{CL}	Input Clamp Diode	V _{CC} = 5.0V, I _{IN} = −12 mA, T _A = 25°C		−0.8	−1.5		V	
I _{IT}	Driver Low Level Disabled Input Current	Driver Disable Input = 2.0V, V _{IN} = 0.4V				−40	μA	
RECEIVER INPUT/BUS OUTPUT								
V _{TH}	High Level Threshold Voltage		DS7833, DS7835	1.4	1.75	2.1	V	
			DS8833, DS8835	1.5	1.75	2.0	V	
V _{TL}	Low Level Threshold Voltage		DS7833, DS7835	0.8	1.35	1.6	V	
			DS8833, DS8835	0.8	1.35	1.5	V	
I _S	Bus Current, Output Disabled or High	V _{BUS} = 4.0V	V _{CC} = Max		25	80	μA	
			V _{CC} = 0V		5.0	80	μA	
		V _{CC} = Max, V _{BUS} = 0.4V			−2.0	−40	μA	
V _{OH}	Logic “1” Output Voltage	V _{CC} = Min	I _{OUT} = −5.2 mA	DS7833, DS7835	2.4	2.75		V
			I _{OUT} = −10.4 mA	DS8833, DS8835	2.4	2.75		V
V _{OL}	Logic “0” Output Voltage	V _{CC} = Min	I _{OUT} = 50 mA		0.28	0.5	V	
			I _{OUT} = 32 mA			0.4	V	
I _{OS}	Output Short Circuit Current	V _{CC} = Max, (Note 4)		−40	−62	−120	mA	
RECEIVER OUTPUT								
V _{OH}	Logic “1” Output Voltage	V _{CC} = Min	I _{OUT} = −2.0 mA	DS7833, DS7835	2.4	3.0		V
			I _{OUT} = −5.2 mA	DS8833, DS8835	2.4	2.9		V
V _{OL}	Logic “0” Output Voltage	V _{CC} = Min, I _{OUT} = 16 mA			0.22	0.4	V	
I _{OT}	Output Disabled Current	V _{CC} = Max, Disable Inputs = 2.0V	V _{OUT} = 2.4V			40	μA	
			V _{OUT} = 0.4V			−40	μA	

Electrical Characteristics (Notes 2 and 3) (Continued)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
RECEIVER OUTPUT (Continued)						
I _{OS}	Output Short Circuit Current	V _{CC} = Max, (Note 4)	DS7833, DS7835	28	-40	-70 mA
			DS8833, DS8835	-30		-70 mA
I _{CC}	Supply Current	V _{CC} = Max	DS7833, DS8833		84	116 mA
			DS7835, DS8835		75	95 mA

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Unless otherwise specified min/max limits apply across the -55°C to +125°C temperature range for the DS7833, DS7835 and across the 0°C to +70°C range for the DS8833, DS8835. All typicals are given for V_{CC} = 5.0V and T_A = 25°C.

Note 3: All currents into device pins shown as positive, out of device pins as negative, all voltages referenced to ground unless otherwise noted. All values shown as max or min on absolute value basis.

Note 4: Only one output at a time should be shorted.

Switching Characteristics V_{CC} = 5.0V, T_A = 25°C

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t _{pd0}	Propagation Delay to a Logic "0" from Input to Bus	(Figure 1)	DS7833/DS8833		14	30 ns
			DS7835/DS8835		10	20 ns
t _{pd1}	Propagation Delay to a Logic "1" from Input to Bus	(Figure 1)	DS7833/DS8833		14	30 ns
			DS7835/DS8835		11	30 ns
t _{pd0}	Propagation Delay to a Logic "0" from Bus to Input	(Figure 2)	DS7833/DS8833		24	45 ns
			DS7835/DS8835		16	35 ns
t _{pd1}	Propagation Delay to a Logic "1" from Bus to Input	(Figure 2)	DS7833/DS8833		12	30 ns
			DS7835/DS8835		18	30 ns
t _{PHZ}	Delay from Disable Input to High Impedance State (from Logic "1" Level)	C _L = 5.0 pF, (Figures 1 and 2)	Driver		8.0	20 ns
			Receiver		6.0	15 ns
t _{PLZ}	Delay from Disable Input to High Impedance State (from Logic "0" Level)	C _L = 5.0 pF, (Figures 1 and 2)	Driver		20	35 ns
			Receiver		13	25 ns
t _{PZH}	Delay from Disable Input to Logic "1" Level (from High Impedance State)	C _L = 5.0 pF, (Figures 1 and 2)	Driver		24	40 ns
			Receiver		16	35 ns
t _{PZL}	Delay from Disable Input to Logic "0" Level (from High Impedance State)	C _L = 5.0 pF, (Figures 1 and 2)	Driver		19	35 ns
			Receiver DS7833/DS8833		15	30 ns
			Receiver DS7835/DS8835		33	50 ns

AC Test Circuits

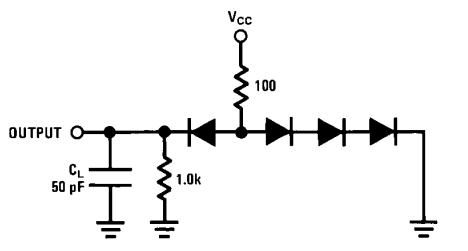


FIGURE 1. Driver Output Load

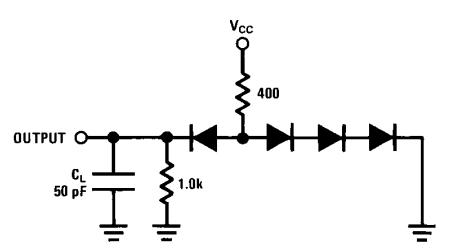
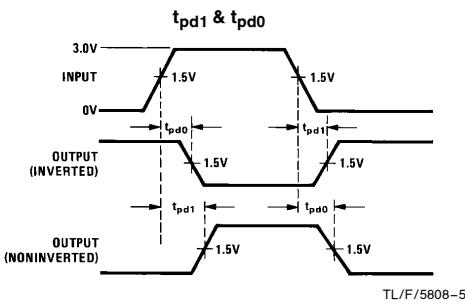


FIGURE 2. Receiver Output Load

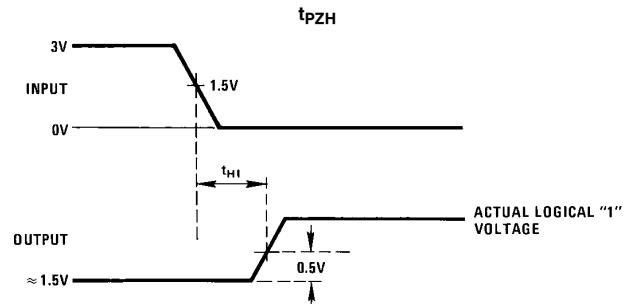
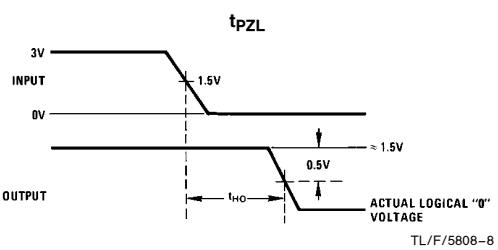
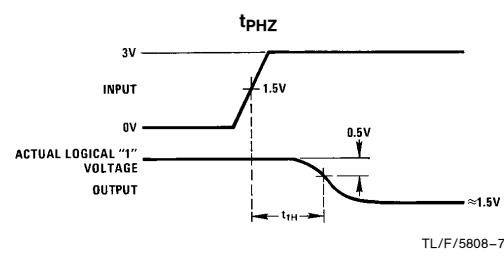
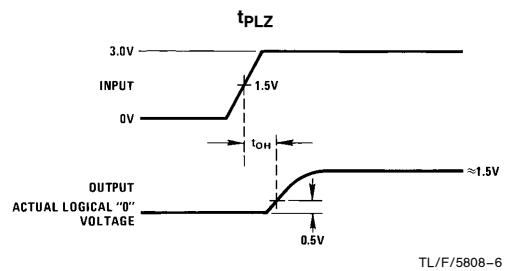
Switching Time Waveforms



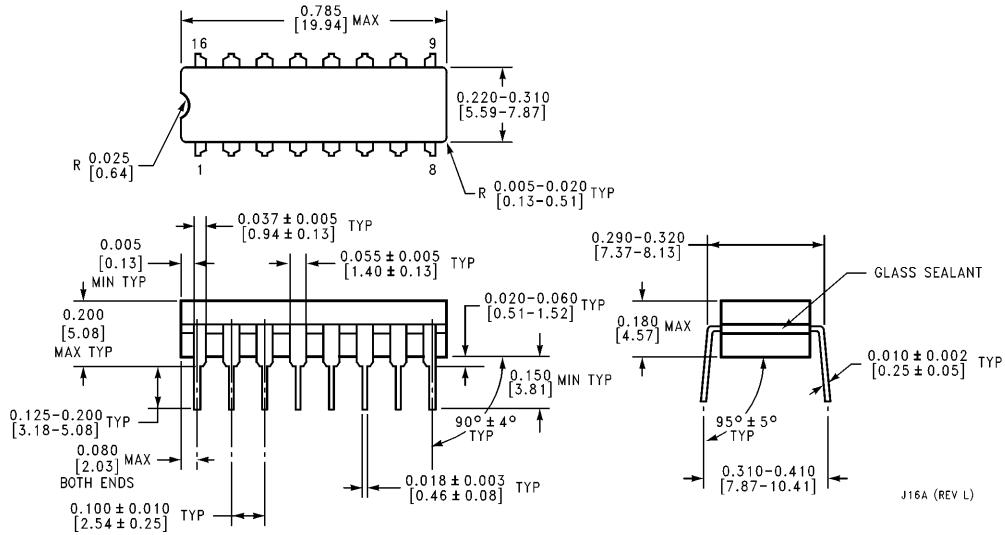
$f = 1 \text{ MHz}$

$t_r = t_f \leq 10 \text{ ns} (10\% \text{ to } 90\%)$

DUTY CYCLE = 50%

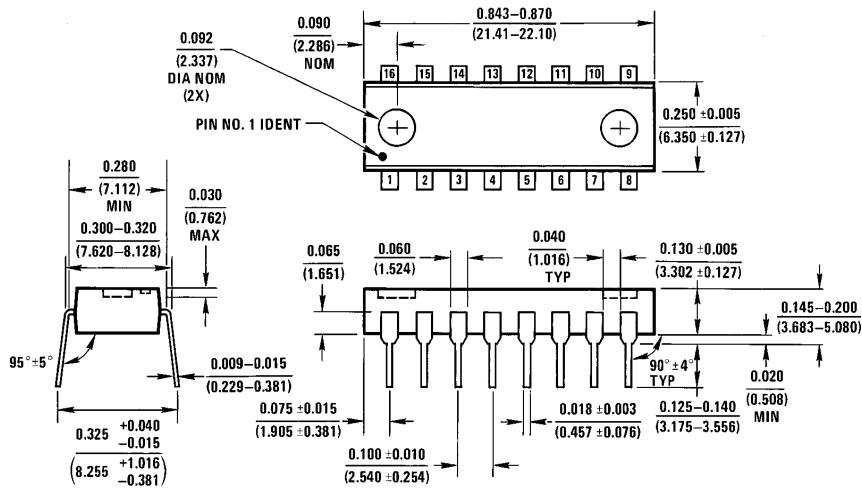


Physical Dimensions inches (millimeters)



Ceramic Dual-In-Line Package (J)
Order Number DS7833J or DS7835J
NS Package Number J16A

Physical Dimensions inches (millimeters) (Continued)



**Molded Dual-In-Line Package (N)
Order Number DS8833N or DS8835N
NS Package Number N16A**

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